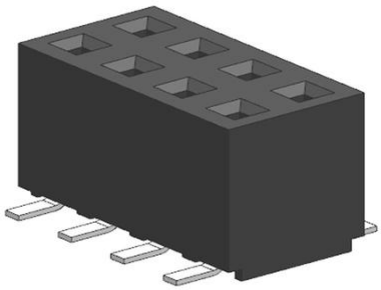
Part Number : 873400824
Product Description : 2.00mm Pitch Milli-Grid Receptacle, Surface Mount (Very Low Profile), Top Entry, with Locating Pegs, 0.38µm Gold (Au) Plating, 8 Circuits, Lead-Free, Tube, Black
Series Number : 87340
Status : Active
Product Category : PCB Headers and Receptacles



Documents and Resources

Drawings

873400824_sd.pdf

PK-87264-0001-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

503940001-AS-000.pdf

PS-87340-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	87340
Description	2.00mm Pitch Milli-Grid Receptacle, Surface Mount (Very Low Profile), Top Entry, with Locating Pegs, 0.38µm Gold (Au) Plating, 8 Circuits, Lead-Free, Tube, Black
Application	Board-to-Board, Signal
Component Type	PCB Receptacle
Product Name	Milli-Grid
UPC	822348473076

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	125V

Physical

Circuits (Loaded)	8
Circuits (maximum)	8
Color - Resin	Black
Durability (mating cycles max)	25
First Mate / Last Break	No
Glow-Wire Capable	No
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.097/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	Yes
PCB Retention	None
Pitch - Mating Interface	2.00mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to Mating Part	No
Polarized to PCB	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	14
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	265

Mates With / Use With

Mates with Part(s)

Description	Part Number
Milli-Grid Vertical Through Hole Headers	87758
Milli-Grid Vertical Surface Mount Headers	87759
Milli-Grid Right-Angle Through Hole Headers	87760